General Description

The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

Features

- Low $R_{DS(on)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity

GreenMOS®

RoHS compliant

Applications

- PC power
- LED lighting
- Telecom power
- Server power
- EV Charger
- Solar/UPS

Key Performance Parameters

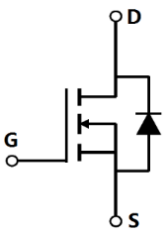
Parameter	Value	Unit
$V_{DS,\ min}$ @ $T_{j(max)}$	1000	V
$I_{D,\ pulse}$	30	A
$R_{DS(ON)\ ,\ max}$ @ V_{GS}=10V	500	mΩ
Q_g	24	nC

Marking Information

Product Name	Package	Marking
OSG95R500HF	TO247	OSG95R500H

Package & Pin Information





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Absolute Maximum Ratings at T_j=25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	950	V
Gate-source voltage	V_{GS}	±30	V
Continuous drain current[1], T_C=25 °C	I_D	10	A
Continuous drain current[1], T_C=100 °C		6.3	
Pulsed drain current[2], T_C=25 °C	$I_{D,\ pulse}$	30	A
Continuous diode forward current[1], T_C=25 °C	I_S	10	A
Diode pulsed current[2], T_C=25 °C	$I_{S,\ pulse}$	30	A
Power dissipation[3], T_C=25 °C	P_D	151	W
Single pulsed avalanche energy[5]	E_{AS}	165	mJ
MOSFET dv/dt ruggedness, V_{DS}=0…480 V	dv/dt	50	V/ns
Reverse diode dv/dt, V_{DS}=0…480 V, I_{SD}≤I_D	dv/dt	15	V/ns
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	$R_{\theta JC}$	0.83	°C/W
Thermal resistance, junction-ambient[4]	$R_{\theta JA}$	62	°C/W

Electrical Characteristics at T_j=25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	950			V	V_{GS}=0 V, I_D=250 μA
		1000				V_{GS}=0 V, I_D=250 μA, T_j=150 °C
Gate threshold voltage	$V_{GS(th)}$	2.9		3.9	V	V_{DS}=V_{GS}, I_D=250 μA
Drain-source on-state resistance	$R_{DS(ON)}$		0.43	0.50	Ω	V_{GS}=10 V, I_D=5 A
			1.60			V_{GS}=10 V, I_D=5 A, T_j=150 °C
Gate-source leakage current	I_{GSS}			100	nA	V_{GS}=30 V
				-100		V_{GS}=-30 V
Drain-source leakage current	I_{DSS}			1	μA	V_{DS}=950 V, V_{GS}=0 V
Gate resistance	R_G		18		Ω	f=1 MHz, Open drain

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Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		1568		pF	V_{GS}=0 V, V_{DS}=50 V, f=100 kHz
Output capacitance	C_{oss}		66		pF	
Reverse transfer capacitance	C_{rss}		1.9		pF	
Effective output capacitance, energy related	$C_{o(er)}$		40		pF	V_{GS} = 0 V, V_{DS} = 0V-400 V
Effective output capacitance, time related	$C_{o(tr)}$		185		pF	
Turn-on delay time	$t_{d(on)}$		33.6		ns	V_{GS}=10 V, V_{DS}=400 V, R_G=2 Ω, I_D=6 A
Rise time	t_r		16.2		ns	
Turn-off delay time	$t_{d(off)}$		54.4		ns	
Fall time	t_f		6.2		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q_g		24		nC	V_{GS}=10 V, V_{DS}=400 V, I_D=6 A
Gate-source charge	Q_{gs}		9.4		nC	
Gate-drain charge	Q_{gd}		3.3		nC	
Gate plateau voltage	$V_{plateau}$		5.6		V	

Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	V_{SD}			1.3	V	I_S=10 A, V_{GS}=0 V
Reverse recovery time	t_{rr}		268		ns	V_R=400 V, I_S=6 A, di/dt=100 A/μs
Reverse recovery charge	Q_{rr}		3.2		μC	
Peak reverse recovery current	I_{rrm}		20.8		A	

Note

1) Calculated continuous current based on maximum allowable junction temperature.
2) Repetitive rating; pulse width limited by max. junction temperature.
3) Pd is based on max. junction temperature, using junction-case thermal resistance.
4) V_{DD}=100 V, V_{GS}=10 V, L=75 mH, starting T_j=25 °C.

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Electrical Characteristics Diagrams

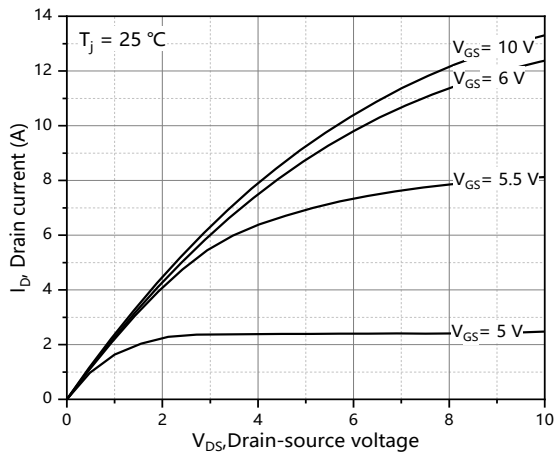


Figure 1. Typ. output characteristics

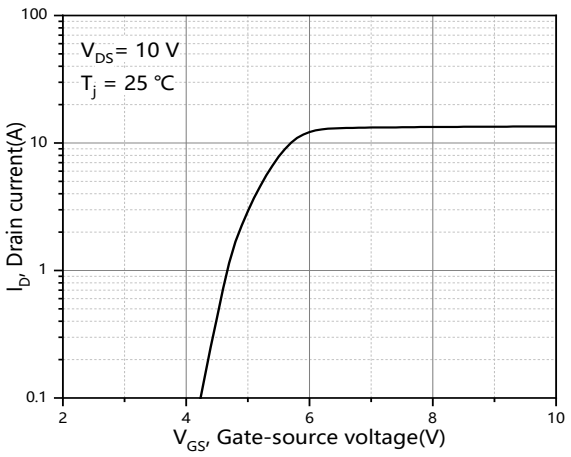


Figure 2. Typ. transfer characteristics

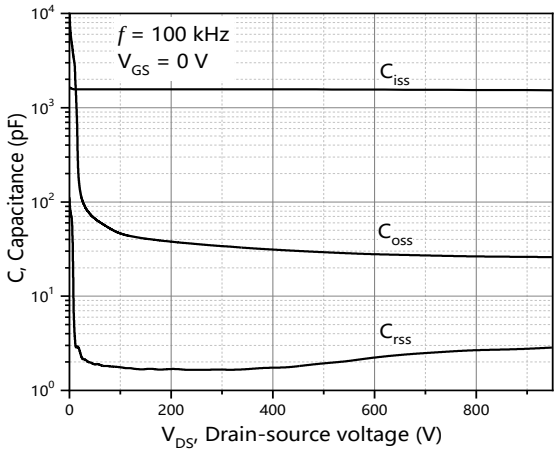


Figure 3. Typ. capacitances

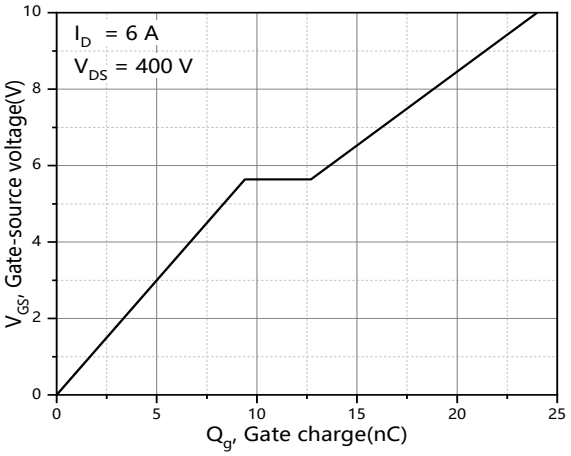


Figure 4. Typ. gate charge

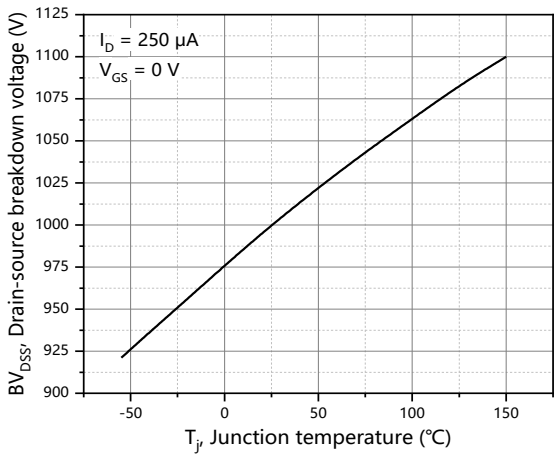


Figure 5. Drain-source breakdown voltage

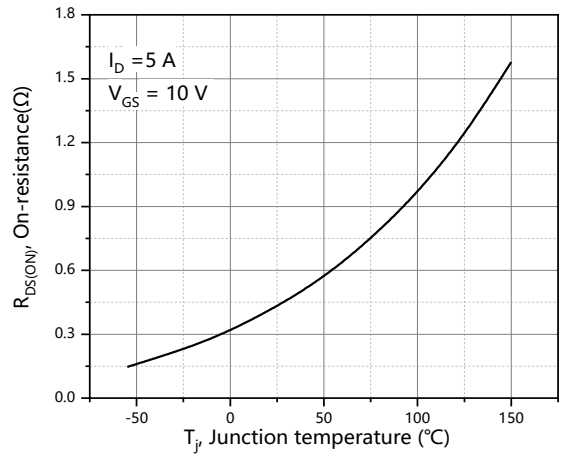


Figure 6. Drain-source on-state resistance

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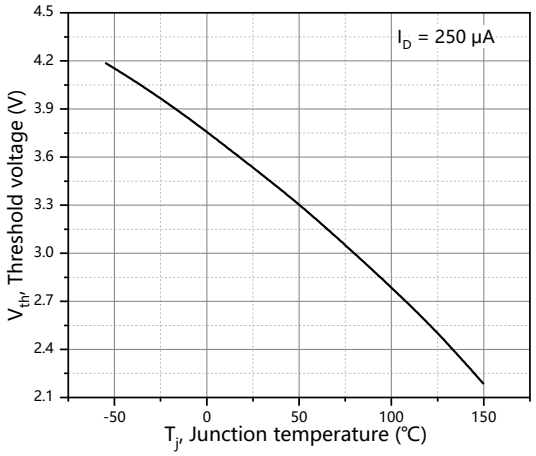


Figure 7. Threshold voltage

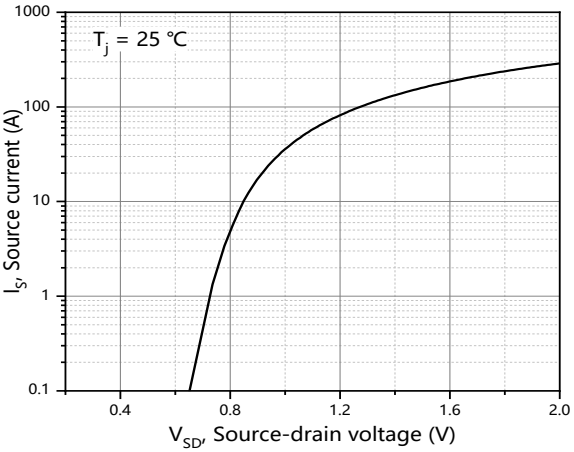


Figure 8. Forward characteristic of body diode

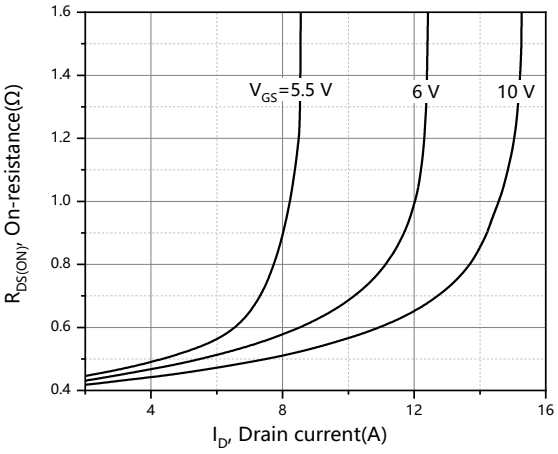


Figure 9. Drain-source on-state resistance

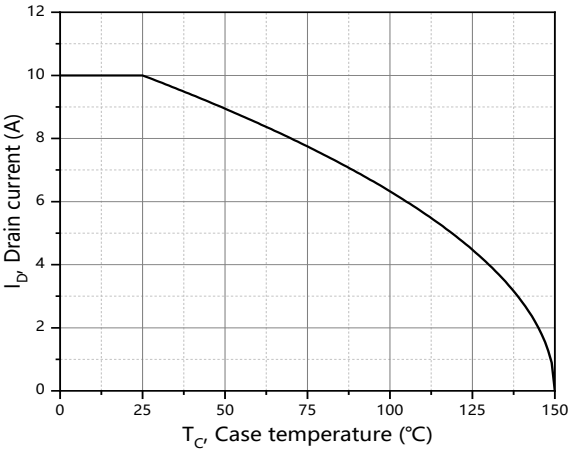


Figure 10. Drain current

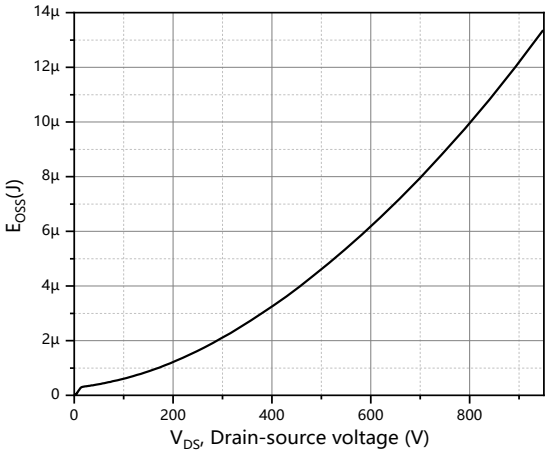


Figure 11. Typ. coss stored energy

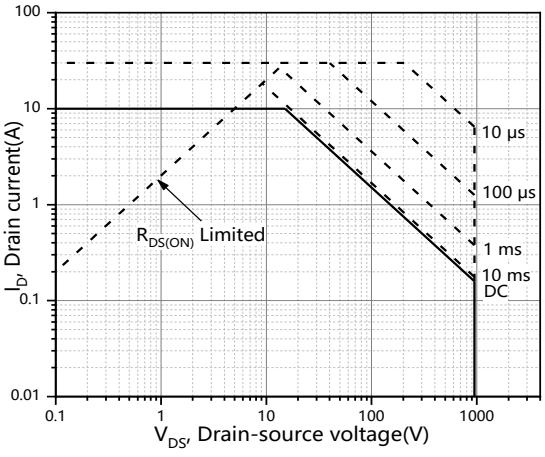


Figure 12. Safe operation area T_C=25 °C

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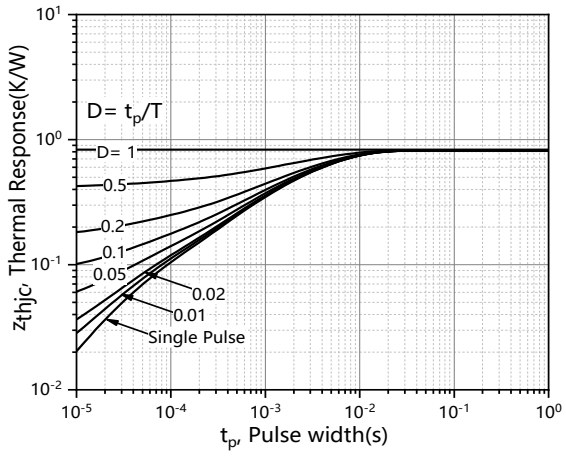


Figure 13. Max. transient thermal impedance

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Test circuits and waveforms

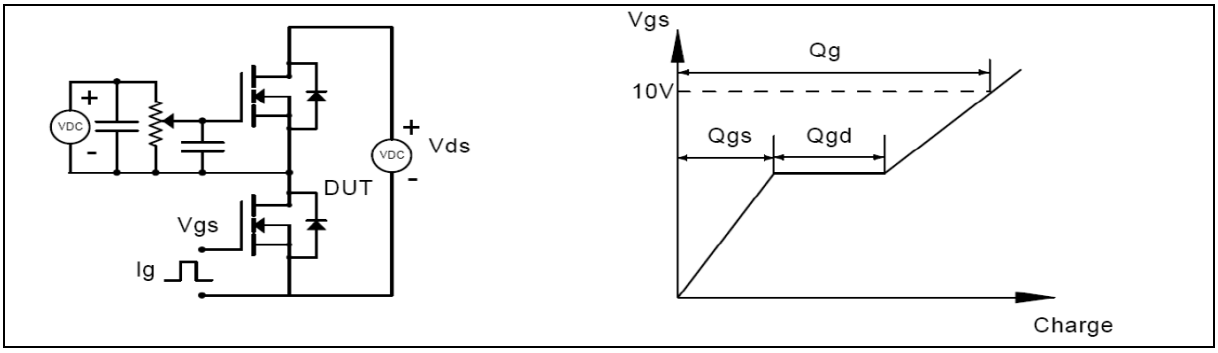


Figure 1. Gate charge test circuit & waveform

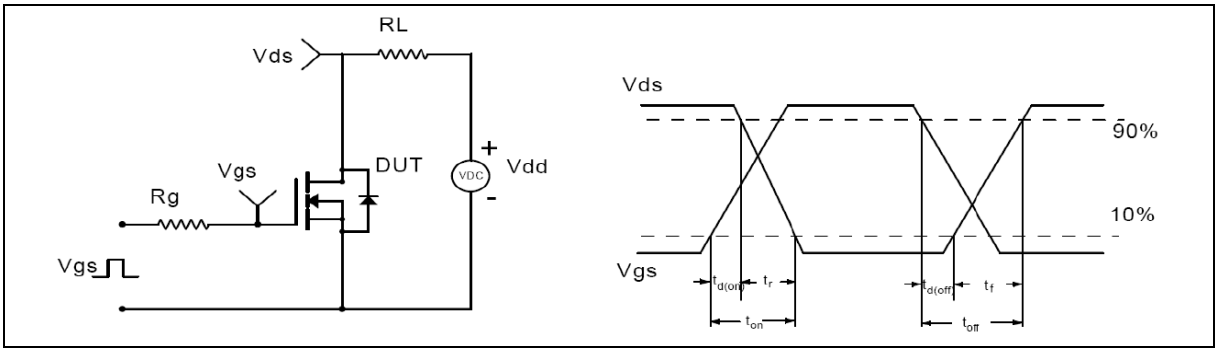


Figure 2. Switching time test circuit & waveforms

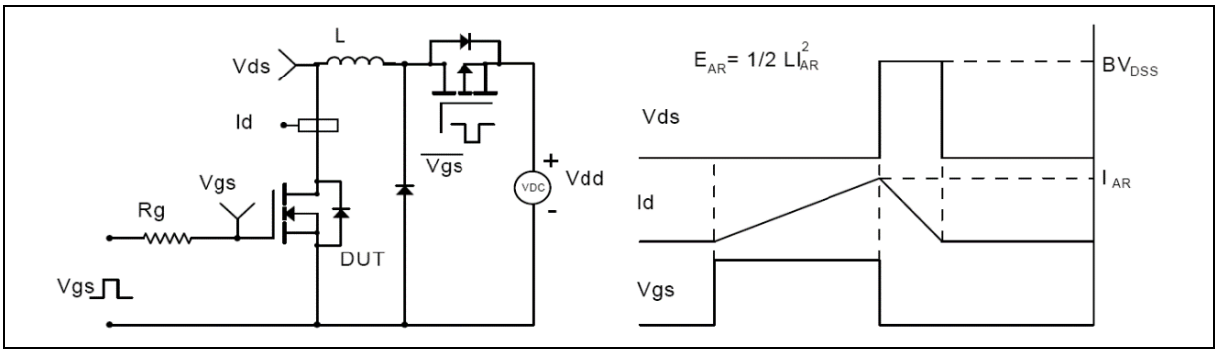


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

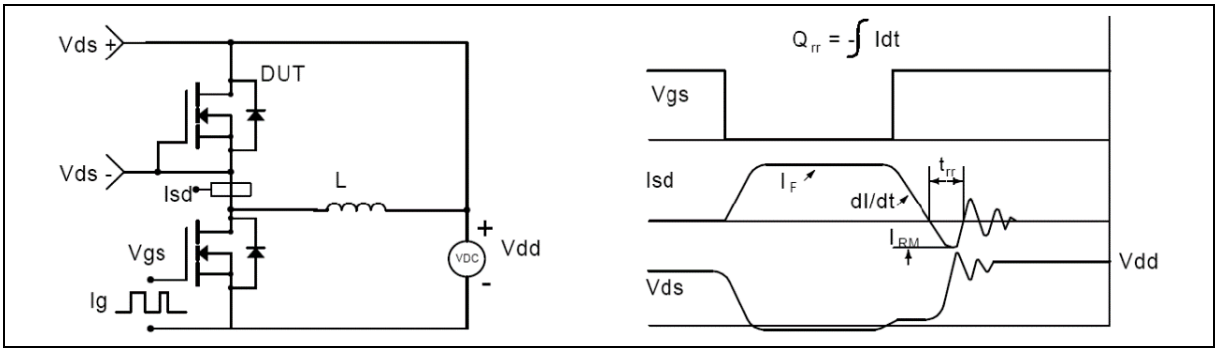
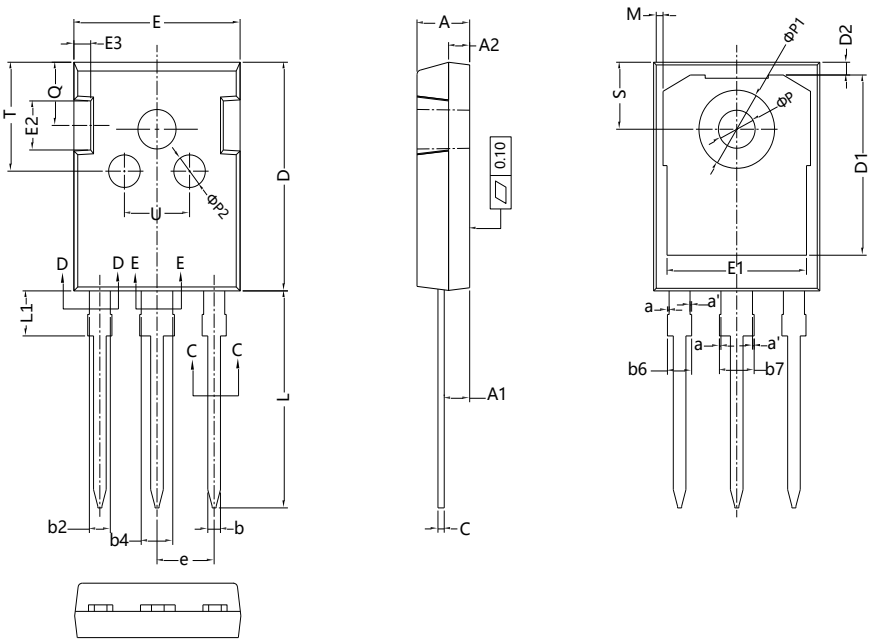


Figure 4. Diode reverse recovery test circuit & waveforms

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Package Information



Symbol	mm		
	Min	Nom	Max
A	4.90	5.00	5.10
A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
a	0.00	-	0.15
a'	0.00	-	0.15
b	1.16	-	1.26
b2	1.96	-	2.06
b4	2.96	-	3.06
b6	-	-	2.25
b7	-	-	3.25
c	0.59	-	0.66
c1	0.58	0.60	0.62
D	20.90	21.00	21.10
D1	16.25	16.55	16.85
D2	1.05	1.17	1.35
E	15.70	15.80	15.90
E1	13.10	13.30	13.50
E2	4.40	4.50	4.60
E3	1.50	1.60	1.70
e	5.436 BSC		
L	19.80	19.92	20.10
L1	-	-	4.30
M	0.35	-	0.95
P	3.40	3.50	3.60
P1	7.00	-	7.40
P2	2.40	2.5	2.6
Q	5.60	-	6.0
S	6.05	6.15	6.25
T	9.8	-	10.20
U	6.00	-	6.40

Version 1: TO247-J package outline dimension

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Ordering Information

Package Type	Units/ Tube	Tubes / Inner Box	Units/ Inner Box	Inner Box/ Carton Box	Units/ Carton Box
TO247-J	30	20	600	4	2400

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG95R500HF	TO247	yes	yes	yes

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